

I. Number	I fits	Search Text	DB	Time stamp
1	157	((wet with etch\$4) with ((undre adj cut\$4) or undercut\$4 or recess\$4)) and base and emitter	USPAT	2003/09/26 08:24
2	79	((wet with etch\$4) with ((undre adj cut\$4) or undercut\$4 or recess\$4)) and base and emitter) and (silicon adj nitride)	USPAT	2003/09/26 08:24
4	1	((wet with etch\$4) with ((undre adj cut\$4) or undercut\$4 or recess\$4)) and base and emitter) and (silicon adj nitride)) and (((side adj wall\$2) or side) with oxidation with expos\$4)	USPAT	2003/09/26 08:26
3	30	((wet with etch\$4) with ((undre adj cut\$4) or undercut\$4 or recess\$4)) and base and emitter) and (silicon adj nitride)) and ((side adj wall\$2) or side) and oxidation and expos\$4	USPAT	2003/09/26 08:46
5	49	((wet with etch\$4) with ((undre adj cut\$4) or undercut\$4 or recess\$4)) and base and emitter) and (silicon adj nitride)) not (((wet with etch\$4) with ((undre adj cut\$4) or undercut\$4 or recess\$4)) and base and emitter) and (silicon adj nitride)) and ((side adj wall\$2) or side) and oxidation and expos\$4	USPAT	2003/09/26 09:05
6	78	((wet with etch\$4) with ((undre adj cut\$4) or undercut\$4 or recess\$4)) and base and emitter) not (((wet with etch\$4) with ((undre adj cut\$4) or undercut\$4 or recess\$4)) and base and emitter) and (silicon adj nitride))	USPAT	2003/09/26 09:05

L Number	Hits	Search Text	DB	Time stamp
1	1172	hashimoto.in. with takashi.in.	USPAT; US-PGPUB; EPO, JPO; DERWENT; IBM_TDB	2003/09/26 11:28
2	9	mikami.in. with kouji.in.	USPAT; US-PGPUB; EPO, JPO; DERWENT; IBM_TDB	2003/09/26 11:28
3	17	udo.in. with tsutomu.in.	USPAT; US-PGPUB; EPO, JPO; DERWENT; IBM_TDB	2003/09/26 11:29
4	432	kondo.in. with masao.in.	USPAT; US-PGPUB; EPO, JPO; DERWENT; IBM_TDB	2003/09/26 11:29
5	31	oue.in. with eiji.in.	USPAT; US-PGPUB; EPO, JPO; DERWENT; IBM_TDB	2003/09/26 11:29
6	1633	(hashimoto.in. with takashi.in.) or (mikami.in. with kouji.in.) or (udo.in. with tsutomu.in.) or (kondo.in. with masao.in.) or (oue.in. with eiji.in.)	USPAT; US-PGPUB; EPO, JPO; DERWENT; IBM_TDB	2003/09/26 11:30
7	32	((hashimoto.in. with takashi.in.) or (mikami.in. with kouji.in.) or (udo.in. with tsutomu.in.) or (kondo.in. with masao.in.) or (oue.in. with eiji.in.)) and (wet adj etch\$4)	USPAT; US-PGPUB; EPO, JPO; DERWENT; IBM_TDB	2003/09/26 11:30
8	3	((hashimoto.in. with takashi.in.) or (mikami.in. with kouji.in.) or (udo.in. with tsutomu.in.) or (kondo.in. with masao.in.) or (oue.in. with eiji.in.)) and (wet adj etch\$4)) and ((wet adj etch\$4) with (undercut\$4 or (undred adj cut\$4) or recess\$4))	USPAT; US-PGPUB; EPO, JPO; DERWENT; IBM_TDB	2003/09/26 11:31